



Revasum Highlights the Benefits of its CMP and Grinding Systems at Semicon West 2019

San Luis Obispo, California – 9 July, 2019: Leading semiconductor equipment company, Revasum, Inc. (ASX: RVS, 'Revasum' or the 'Company') is pleased to be an exhibitor, and a co-sponsor of the Smart WorkForce Pavilion this week, at the 2019 Semicon West trade show. The company will exhibit in the South Hall, Booth 833.

“Semicon West provides an excellent opportunity to showcase the advantages of Revasum’s grind and CMP solutions for a broad range of applications at 200mm and below, including SiC and other challenging compound materials,” said Sarah Okada, VP of Product Management and Marketing for Revasum. “We continue to support substrate and device makers through our production-proven technologies, process development, and integration support.”

Revasum will also be presenting during events in conjunction with Semicon West. Rob Rhodes, CTO will be presenting “The Whole World is Getting SiC” during the NCCAVS Technical Meeting. In support of the Workforce Pavilion, Thea Davis, Sr. Marketing Manager will be participating in a panel on “Creating a Culture of Inclusivity” in the tech industry.

Semicon West is a premier annual microelectronics trade show spotlighting development in the semiconductor world that is rapidly moving to BEYOND SMART. The show is being held on July 9th-11th in San Francisco and connects the entire extended microelectronics supply chain. For more information visit their website: <http://www.semiconwest.org/>

Safe Harbor Statement

This announcement contains forward-looking statements, which address a variety of subjects including, for example, financial projections, our statements regarding expected events, including expected revenue and earnings, system shipments, expected product offerings, product development, market adoption and technical advances. Statements that are not historical facts, including statements about our beliefs, plans and expectations, are forward-looking statements. Such statements are based on our current expectations and information currently available to management and are subject to a number of factors and uncertainties, many of which are outside the control of the Company, which could cause actual results to differ materially from those described in the forward-looking statements. The Company's management believes that these forward-looking statements are reasonable as and when made. However, you should not place undue reliance on any such forward-looking statements because such statements speak only as of the date they are made. Revasum does not undertake any obligation to publicly update or revise any



forward-looking statements, whether as a result of new information, future events or otherwise, except as required by law or the ASX Listing Rules. In addition, forward-looking statements are subject to certain risks and uncertainties that could cause actual results, events and developments to differ materially from our historical experience and our present expectations or projections.

About Revasum, Inc. (ASX: RVS)

Revasum (ARBN: 629 268 533) specializes in the design and manufacturing of equipment used for the global semiconductor industry. Revasum's equipment helps drive advanced manufacturing technology for critical growth markets, including automotive, IoT, and 5G. Our product portfolio includes state of the art equipment for the grinding, polishing, and chemical mechanical planarization processes used to manufacture devices for those key end markets. All of Revasum's equipment is designed and developed in close collaboration with our customers. Learn how we create the equipment that generates the technology of today and tomorrow, visit www.revasum.com.

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